

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SINO-AMERICAN SILICON PRODUCTS INC.	06/16/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HANNSTAR DISPLAY CORPORATION
<b>Street Address:</b>	4F, NO.15, LN 168, XING SHAN RD., NEIHU DIST.,
<b>City:</b>	TAIPEI CITY
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	114
<b>PROPERTY NUMBERS Total: 4</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	8203136
Patent Number:	8742442
Patent Number:	8624279
Patent Number:	9068279
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	TW0149
<b>NAME OF SUBMITTER:</b>	BELINDA LEE
<b>SIGNATURE:</b>	/Belinda Lee/
<b>DATE SIGNED:</b>	07/20/2021
<b>Total Attachments: 2</b>	
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## ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS

**Sino-American Silicon Products Inc.**, a corporation having a place of business at 4F, No.8, Industrial East Road 2, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C. (hereafter ASSIGNOR) has been assigned or otherwise has an ownership interest in certain new and useful improvements as set forth in the patents and patent applications listed in attached Appendix A.

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby:

- 1) Sell(s), assign(s) and transfer(s) to **HannStar Display Corporation**, a corporation having a place of business at 4F, No.15, Ln 168, Xing Shan Rd., Neihu Dist., Taipei City 114, Taiwan, R.O.C. (hereinafter referred to as "ASSIGNEE") the entire right, title and interest in any and all improvements and inventions disclosed in, application(s) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed therein.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application(s) or any division(s), continuation(s), substitute(s), re-examination(s) or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application(s), as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative(s), and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that ASSIGNOR has not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signatures of Assignor and Assignee  
with the execution date of this Assignment indicated beside the signature(s).

Assignor (Conveying Party):

By: Chuck Hsu Date: 2021.6.16  
Typed Name: **Chuck Hsu**  
Title: **Vice President**  
Company: **Sino-American Silicon Products Inc.**  
4F, No.8, Industrial East Road 2, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

Assignee (Receiving Party):

By: Po-Hsing Chiu Date: 2021.7.12  
Typed Name: **Po-Hsing Chiu**  
Title: **Vice President**  
Company: **HannStar Display Corporation**  
4F, No.15, Ln 168, Xing Shan Rd., Neihu Dist., Taipei City 114, Taiwan, R.O.C.

Appendix A

	<b>Appl. No.</b>	<b>Patent No.</b>	<b>Title</b>	<b>Attorney Docket No.</b>
1	13/024,226	US8203136B2	Epitaxial substrate, semiconductor light-emitting device using such epitaxial substrate and fabrication thereof	111692-US-PA
2	13/450,424	US8742442B2	Method for patterning an epitaxial substrate, a light emitting diode and a method for forming a light emitting diode	111694-US-PA
3	13/472,480	US8624279B2	Light emitting diode substrate and light emitting diode	038325-US-PA
4	13/067,710	US9068279B2	Epitaxial substrate having nano-rugged surface and fabrication thereof	111698-US-PA